

RCD041N25 Nch 250V 4.0A Power MOSFET

Datasheet

V _{DSS}	250V
R _{DS(on)} (Max.)	1300mΩ
I _D	4.0A
P _D	29W

Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Drive circuits can be simple.
- 4) Parallel use is easy.
- 5) Pb-free lead plating ; RoHS compliant
- 6) 100% Avalanche tested

Application

Switching Power Supply

Automotive Motor Drive

Automotive Solenoid Drive

• Absolute maximum ratings($T_a = 25^{\circ}C$)

Packaging specifications

Outline

	Packaging	Taping
	Reel size (mm)	330
Type	Tape width (mm)	16
Туре	Basic ordering unit (pcs)	2,500
	Taping code	TL
	Marking	C41N25

Parameter		Symbol	Value	Unit
Drain - Source voltage		V _{DSS}	250	V
Continuous drain current	$T_c = 25^{\circ}C$	ا _D ^{*1}	±4.0	A
	$T_c = 100^{\circ}C$	ا _D *1	±2.2	А
Pulsed drain current		I _{D,pulse} *2	16	А
Gate - Source voltage		V _{GSS}	±30	V
Avalanche energy, single pulse		E _{AS} ^{*3}	1.61	mJ
Avalanche current		I _{AR} ^{*3}	2.0	А
Power dissipation	$T_c = 25^{\circ}C$	P _D	29	W
rower dissipation	$T_{a} = 25^{\circ}C^{*4}$	P _D	0.85	W
Junction temperature		Tj	150	°C
Range of storage temperature		T _{stg}	-55 to +150	°C

Thermal resistance

Parameter	Symbol	Values			Unit	
Farameter	Symbol Min.		Тур.	Max.	Unit	
Thermal resistance, junction - case	R _{thJC}	-	-	4.3	°C/W	
Thermal resistance, junction - ambient *4	R _{thJA}	-	-	147	°C/W	
Soldering temperature, wavesoldering for 10s	T_{sold}	-	-	265	°C	

•Electrical characteristics($T_a = 25^{\circ}C$)

Demonster	Oursela e l		Values				
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	250	-	-	V	
		$V_{DS} = 250V, V_{GS} = 0V$			10		
Zero gate voltage drain current	I _{DSS}	T _j = 25°C			10	μA	
	·D88	$V_{DS} = 250V, V_{GS} = 0V$		_	100	μΛ	
		T _j = 125°C			100		
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	±100	nA	
Gate threshold voltage	V _{GS (th)}	$V_{DS} = 10V, I_D = 1mA$	3.5	-	5.5	V	
	\mathbf{O}	$V_{GS} = 10V, I_{D} = 2.0A$	-	930	1300		
Static drain - source on - state resistance	R _{DS(on)} *5	V _{GS} = 10V, I _D = 2.0A T _i = 125°C	-	1950	2730	mΩ	
Forward transfer admittance	g _{fs}	$V_{DS} = 10V, I_{D} = 2.0A$	1.1	2.2	-	S	

•Electrical characteristics(T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	350	-	
Output capacitance	C _{oss}	$V_{DS} = 25V$	-	30	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	15		
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 125V, V_{GS} = 10V$	-	15		
Rise time	t _r *5	I _D = 2.0A	-	14	-	20
Turn - off delay time	t _{d(off)} *5	$R_L = 12\Omega$	- (18	-	ns
Fall time	t_{f}^{*5}	R _G = 10Ω		15	-	

•Gate Charge characteristics($T_a = 25^{\circ}C$)

●Gate Charge characteristics	(T _a = 25°C)					
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Total gate charge	Q_{g}^{*5}	V _{DD} ≃ 125V		8.5	-	
Gate - Source charge	Q _{gs} *5	I _D = 4.0A	-	3.5	-	nC
Gate - Drain charge	Q _{gd} *5	V _{GS} = 10V	-	3.5	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 125V, I_D = 4.0A$	-	7.8	-	V

●Body diode electrical characteristics (Source-Drain)(T_a = 25°C)

Parameter	Symbol Conditions		Values			Unit
	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous source current	I _S *1	T _c = 25°C	-	-	4	А
Pulsed source current	I _{SM} *2	$T_{c} = 25 \text{ O}$	-	-	16	А
Forward voltage	V_{SD} *5	$V_{GS} = 0V, I_{S} = 4.0A$	-	-	1.5	V
Reverse recovery time	t _{rr} *5	I _S = 2.0A	-	80	-	ns
Reverse recovery charge	Q _{rr} ^{*5}	di/dt = 100A/µs	-	200	-	nC

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10 $\mu s,$ Duty cycle \leq 1%

*3 L \simeq 500 μ H, V_{DD} = 50V, Rg = 10 Ω , starting T_j = 25°C

*4 Mounted on a epoxy PCB FR4 (20mm × 20mm × 0.8mm)

*5 Pulsed

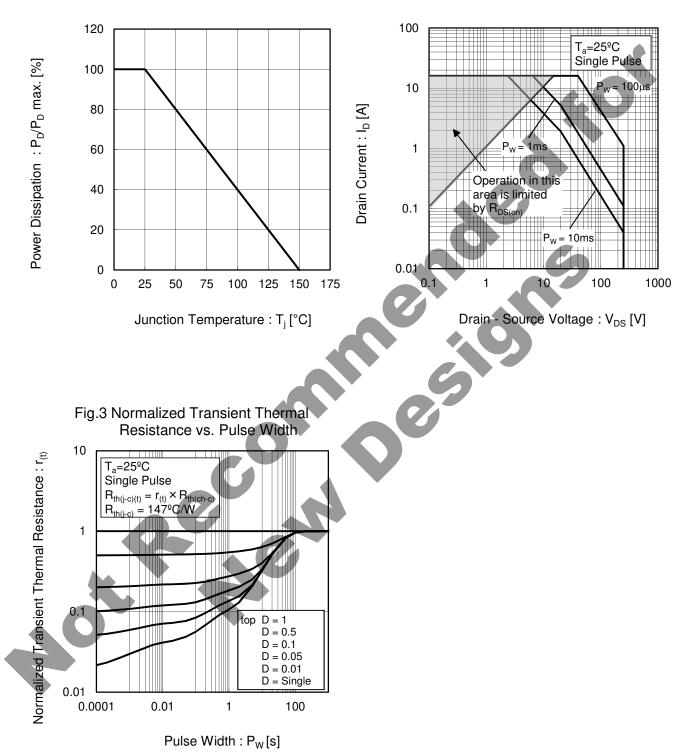


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

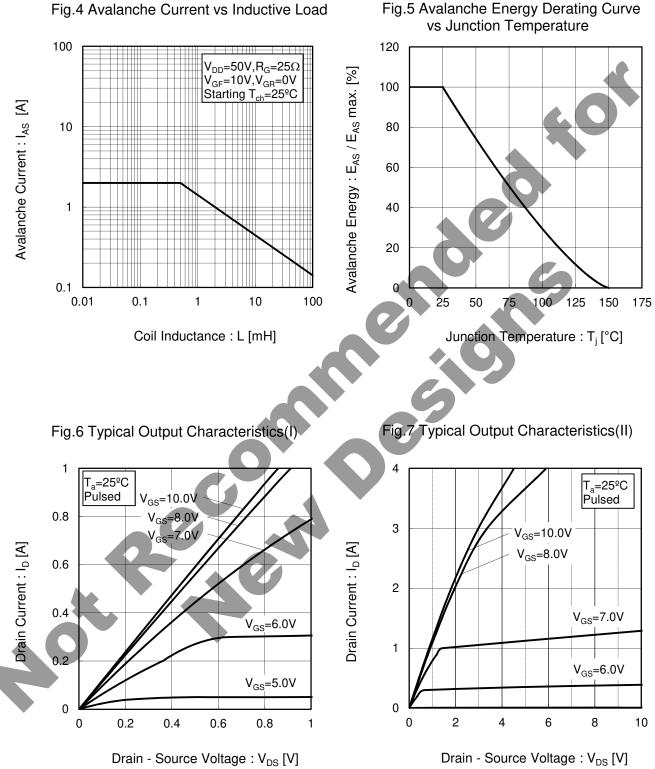
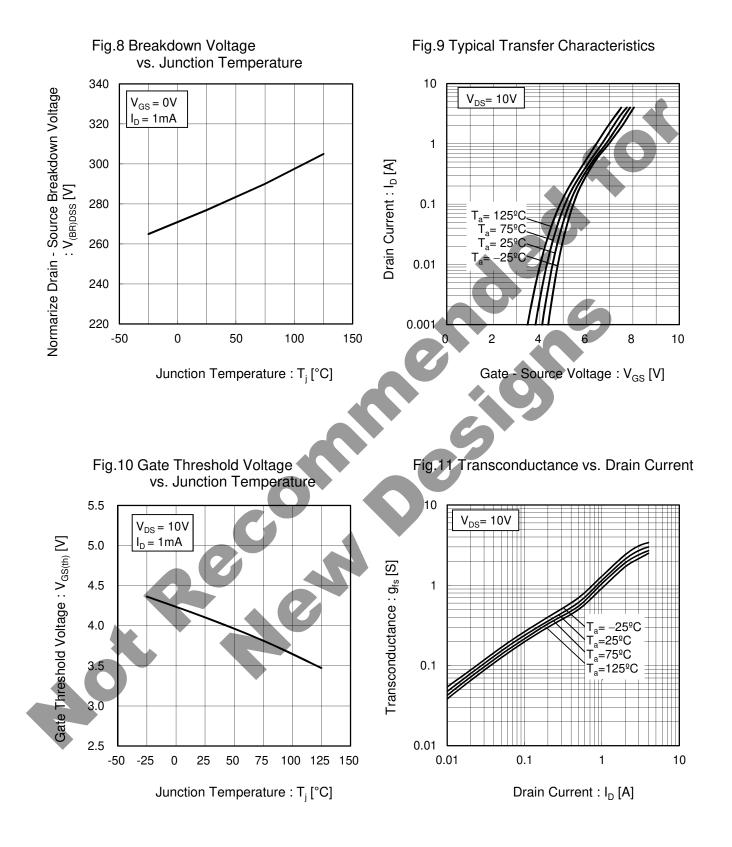
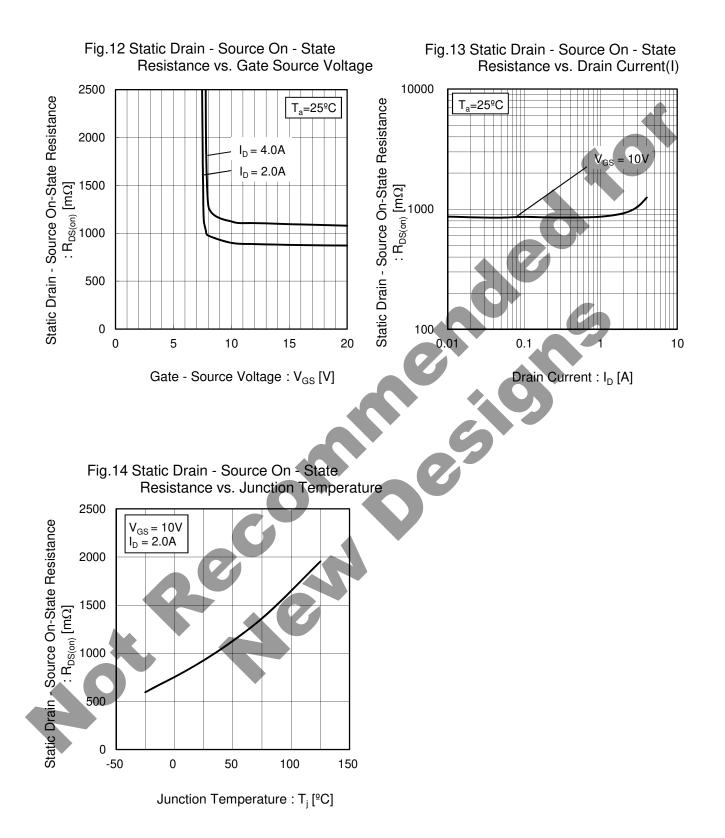
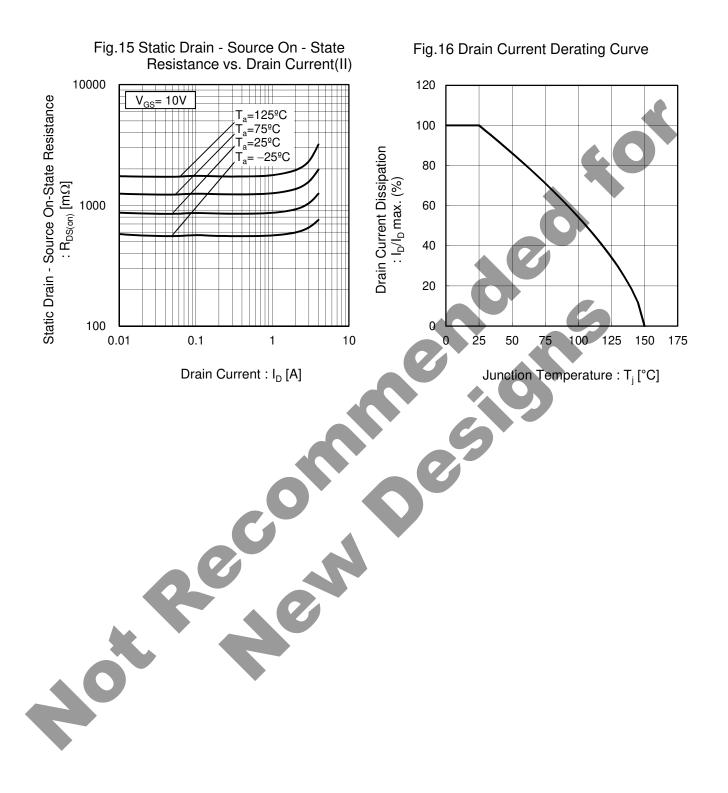


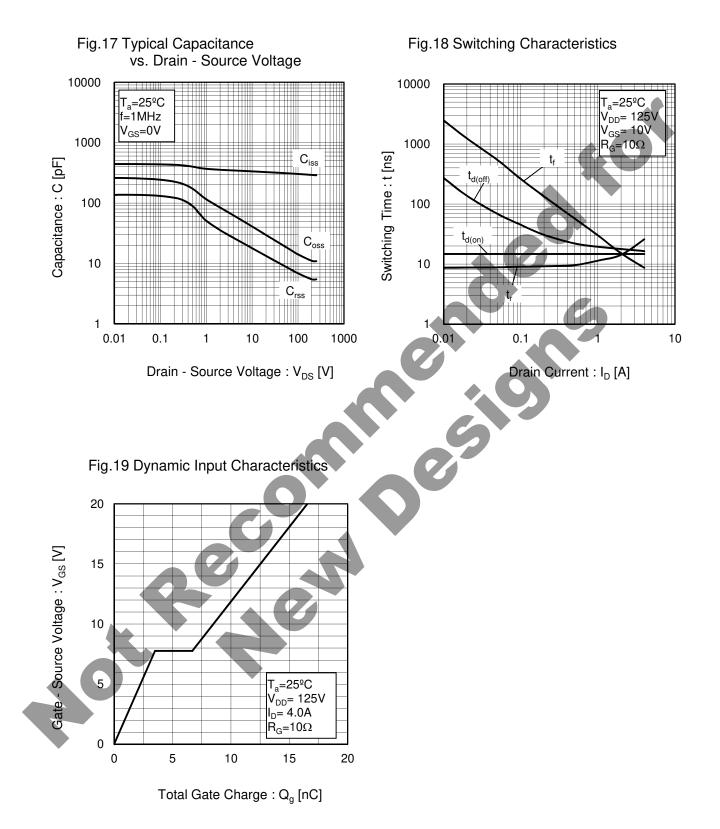
Fig.4 Avalanche Current vs Inductive Load

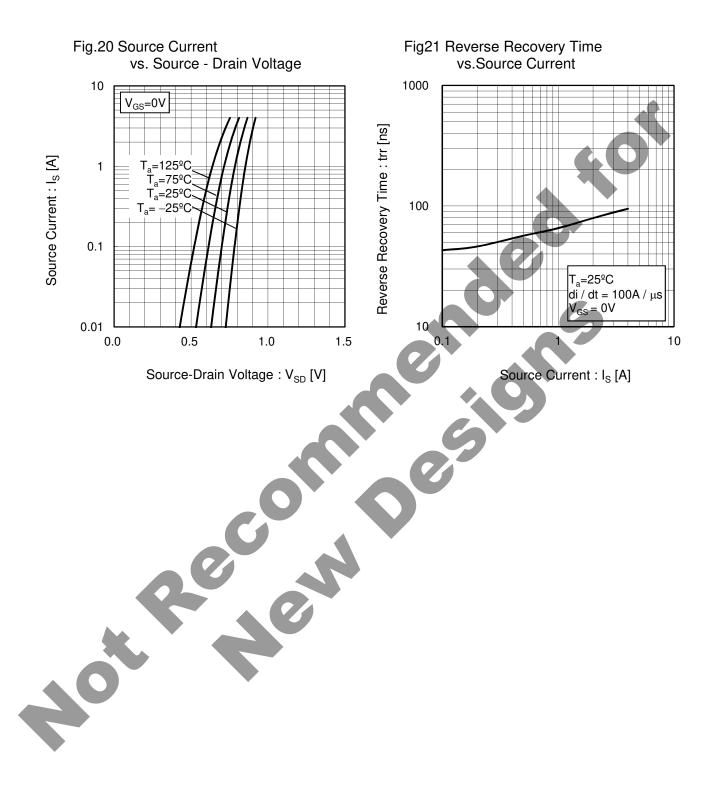






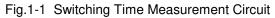








Measurement circuits



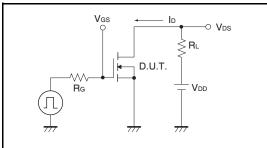


Fig.2-1 Gate Charge Measurement Circuit

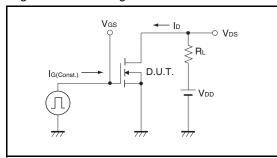


Fig.3-1 Avalanche Measurement Circuit

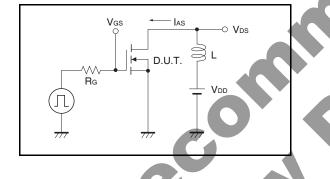
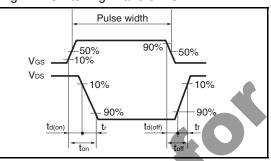
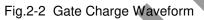


Fig.1-2 Switching Waveforms





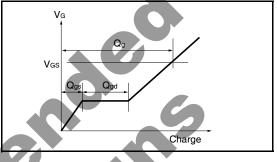
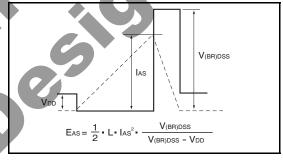
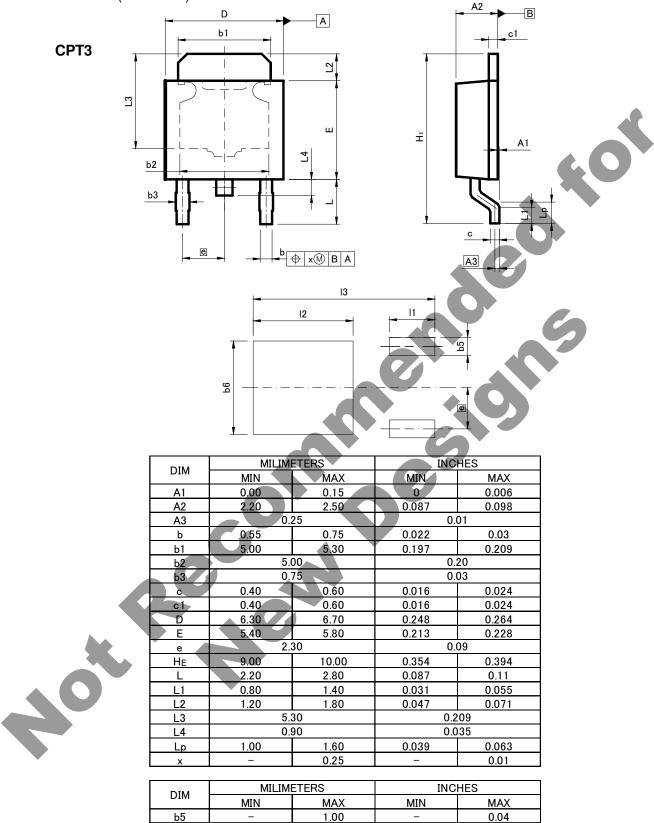


Fig.3-2 Avalanche Waveform



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•Dimensions (Unit : mm)



Billi	MIN	MAX	MIN	MAX
b5	-	1.00	-	0.04
b6	-	5.20	-	0.205
1	-	2.50	-	0.098
12	-	5.50	-	0.217
13	-	10.00	-	0.394

Dimension in mm/inches

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	(Note1) Medical E	ific Applications		
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JAPAN	USA	EU	CHINA
CLASSⅢ		CLASS II b	
CLASSⅣ	CLASSⅢ	CLASSⅢ	- CLASSII

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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